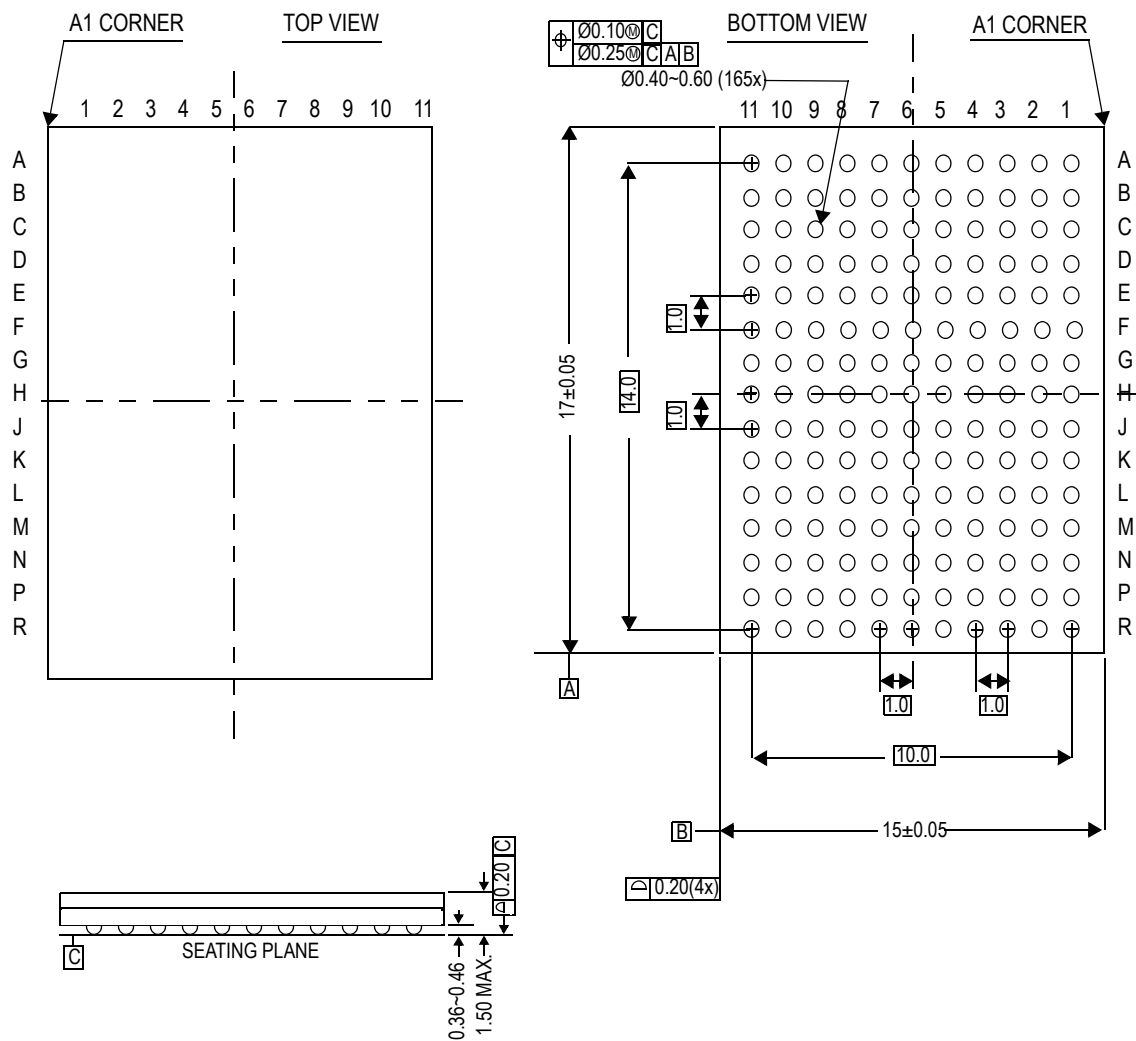


165-Bump BGA (15 mm x 17 mm) Daisy Chain Package

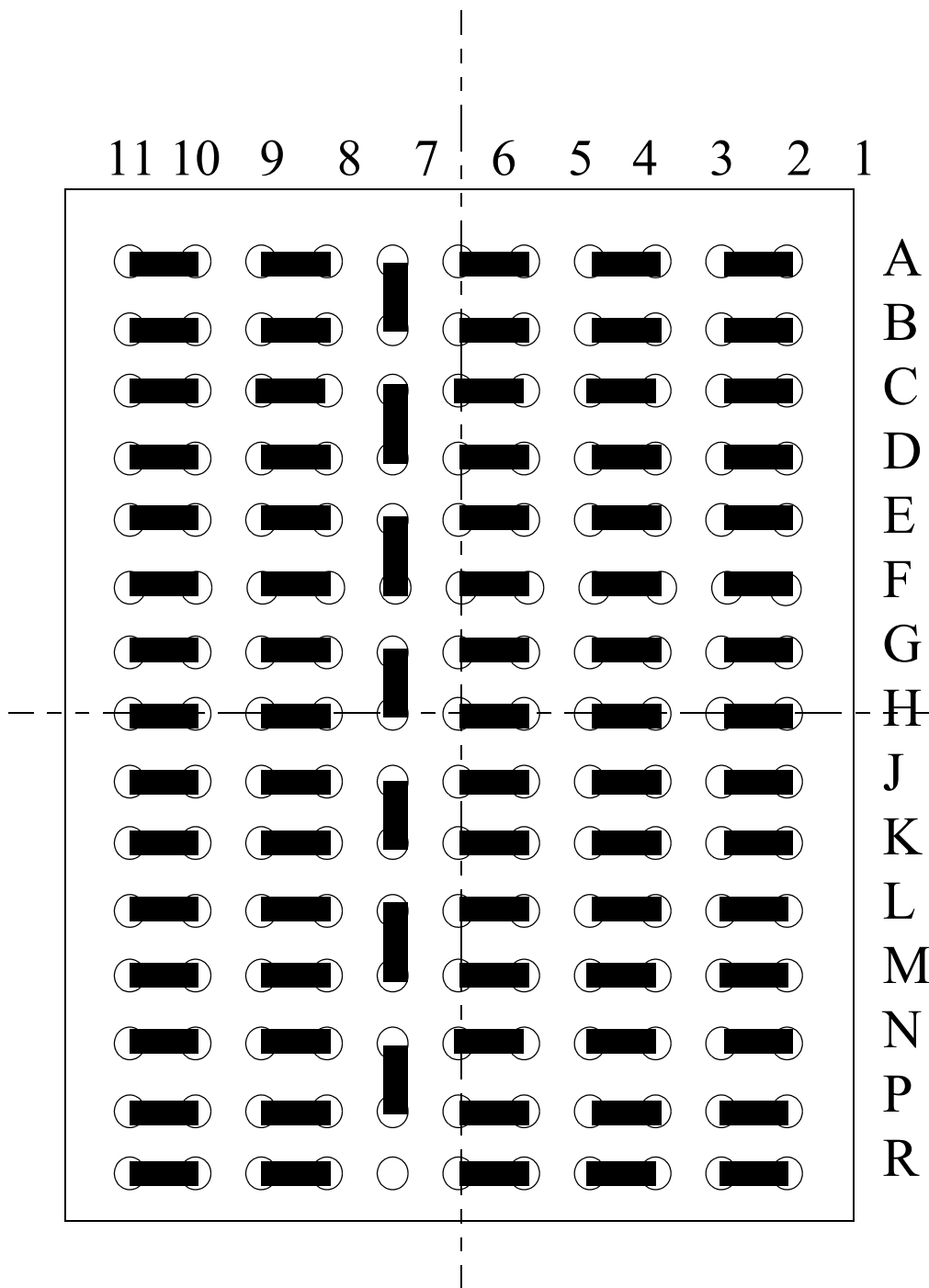
Description

This mechanical daisy chain test vehicle is designed to represent the 165-Bump BGA package. It is used for second level interconnect assembly test and continuity verification.

Package Dimensions—165-Bump FPBGA (Package E)



165-Bump FPBGA Interconnection Diagram

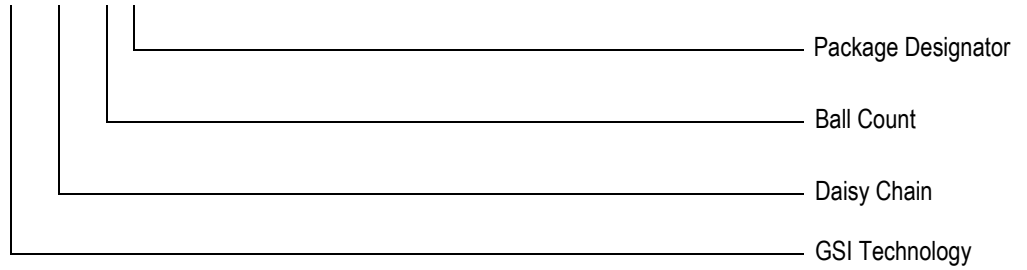


Ordering Information

165-Bump BGA (15 mm x 17 mm)

Daisy Chain Package

GSDC165E



165-Bump BGA (15 mm x 17 mm)

Daisy Chain Package
RoHS-compliant Option

GSDC165GE

